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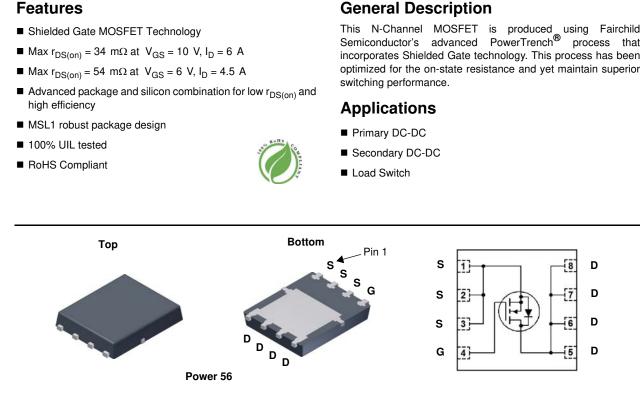
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N-Channel Shielded Gate PowerTrench[®] MOSFET

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Param	eter		Ratings	Units	
V _{DS}	Drain to Source Voltage			100	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T _C = 25 °C		26		
I _D	-Continuous	T _A = 25 °C	(Note 1a)	6	Α	
	-Pulsed			30		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	50	mJ	
P _D	Power Dissipation	T _C = 25 °C		48	14/	
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	W	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

FAIRCHILD

FDMS86105

100 V, 26 A, 34 mΩ

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	2.6	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 1a) 50	C/ W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86105	FDMS86105	Power 56	13 "	12 mm	3000 units

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October 2014

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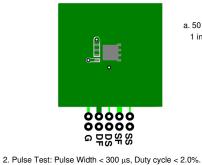
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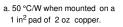
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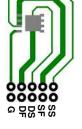
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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					1
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	100			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		70		mV/°C
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 80 V, V_{GS} = 0 V$			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 V, V_{DS} = 0 V$			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	2.0	2.8	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-9		mV/°C
	Static Drain to Source On Resistance	$V_{GS} = 10 V, I_D = 6 A$		27	34	
r _{DS(on)}		$V_{GS} = 6 V, I_D = 4.5 A$	37 54		54	mΩ
()		$V_{GS} = 10$ V, $I_D = 6$ A, $T_J = 125$ °C		46	57	1
9 _{FS}	Forward Transconductance	$V_{DS} = 10 V, I_{D} = 6 A$		15		S
C _{iss} C _{oss} C _{rss}	Output Capacitance Reverse Transfer Capacitance Gate Resistance	— V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz		114 5 0.9	155 10	pF pF
R _g				0.9		Ω
	g Characteristics			0.7	14	
t _{d(on)}	Turn-On Delay Time Rise Time			6.7 2.1	14 10	ns
t _r		$V_{DD} = 50$ V, $I_D = 6$ A, V _{GS} = 10 V, R _{GEN} = 6 Ω		12	22	ns
t _{d(off)}	Turn-Off Delay Time Fall Time			2.4	10	ns ns
t _f Q _q	Total Gate Charge	V _{GS} = 0 V to 10 V		7.5	10	nC
Q _g	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V$ $V_{DD} = 50 V,$		4.2	6	nC
Q _{gs}	Gate to Source Charge	$I_{\rm D} = 6 \text{ A}$		2.1	Ŭ	nC
Q _{gd}	Gate to Drain "Miller" Charge			1.7		nC
	urce Diode Characteristics					
	Source-Drain Diode, Forward Voltage $V_{GS} = 0 \text{ V}, \text{ I}_S = 2 \text{ A}$ (Note 2)		0.76	1.2		
V _{SD}				0.82	1.3	V
t _{rr}	Reverse Recovery Time	I _F = 6 A, di/dt = 100 A/μs		38	61	ns
Q _{rr}	Reverse Recovery Charge	$\mu_{\rm F} = 0$ A, $u_{\rm F} u_{\rm F} = 100$ A/µ3		32	51	nC

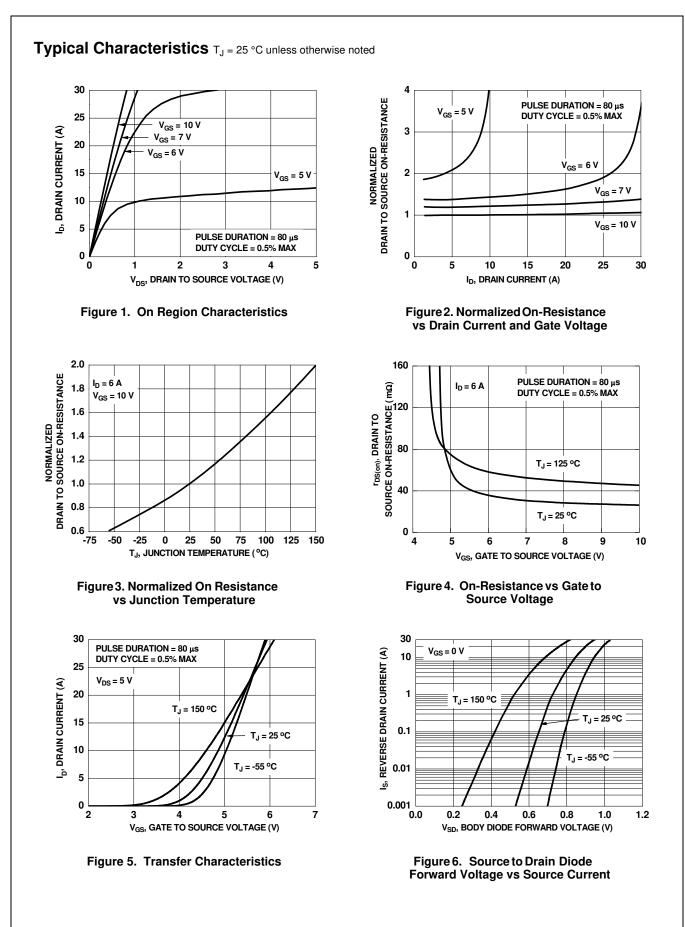


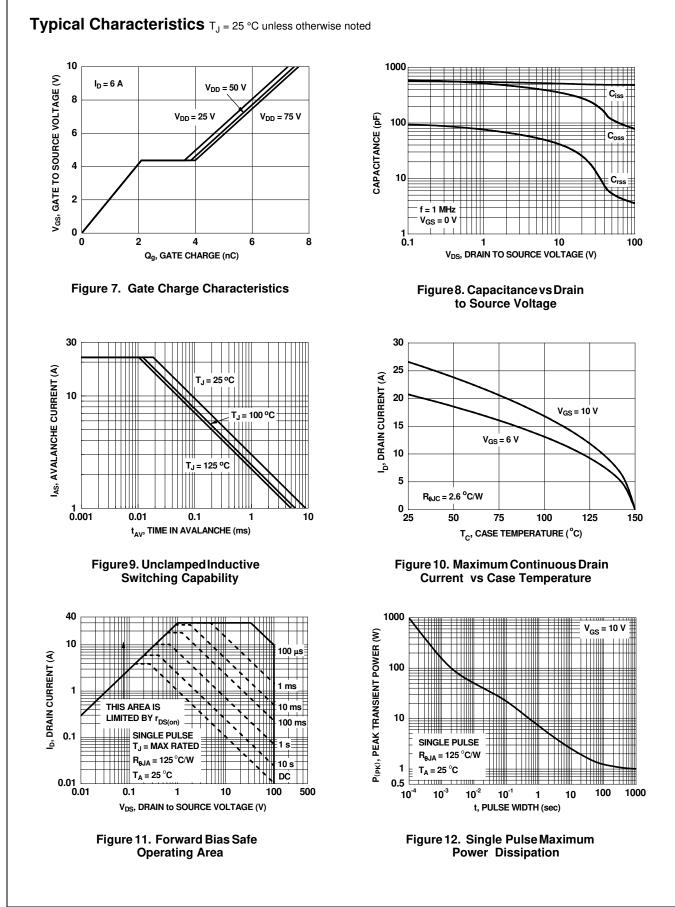
3. Starting T_J = 25 °C, L = 1 mH, I_{AS} = 10 A, V_{DD} = 90 V, V_{GS} = 10 V.

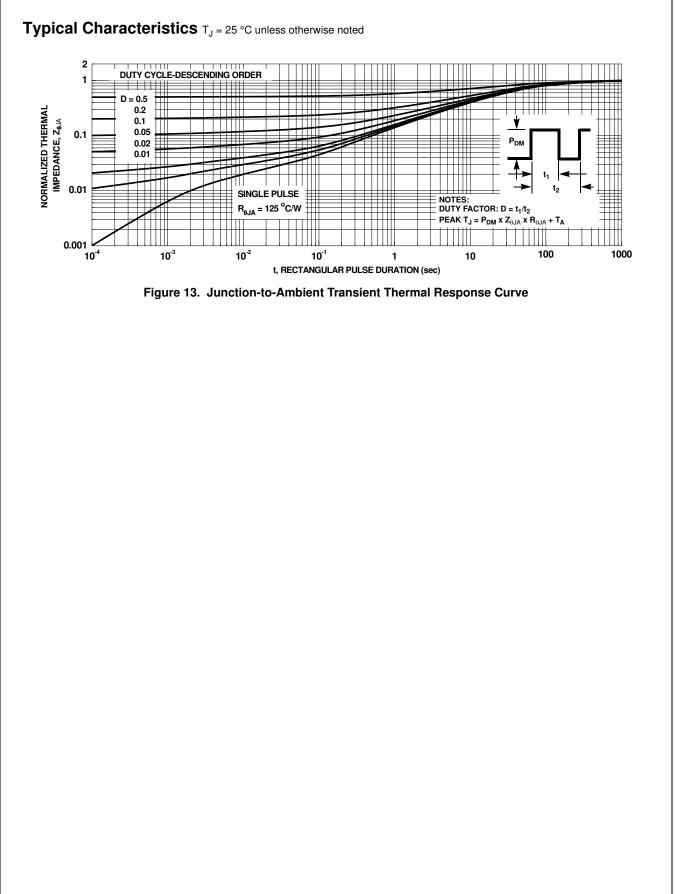


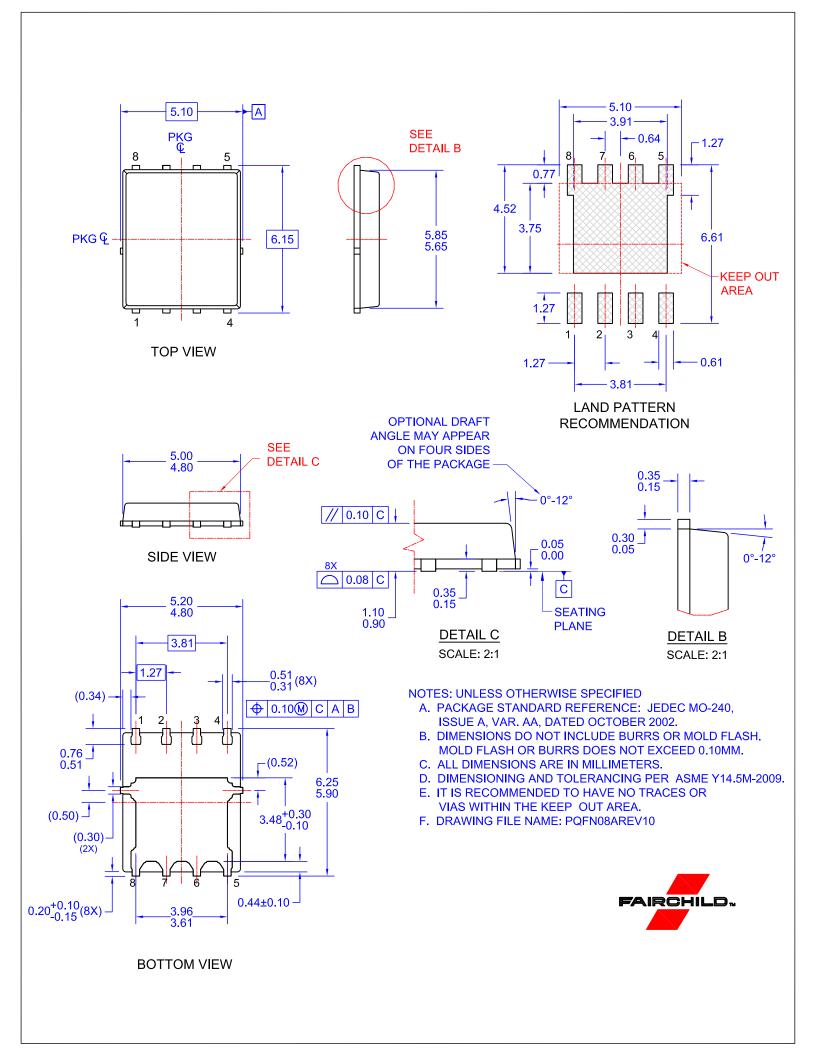


b. 125 °C/W when mounted on a minimum pad of 2 oz copper.









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